

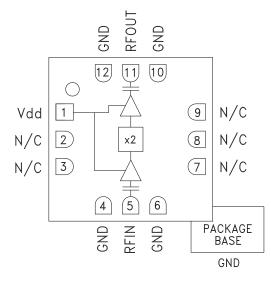


Typical Applications

The HMC448LC3B is suitable for:

- Clock Generation Applications: SONET OC-192 & SDH STM-64
- Point-to-Point & VSAT Radios
- Test Instrumentation
- Military & Space

Functional Diagram



SMT GaAs MMIC x2 ACTIVE FREQUENCY **MULTIPLIER, 20 - 25 GHz OUTPUT**

Features

Output Power: +11 dBm Wide Input Power Range: -4 to +6 dBm Fo, 3Fo Isolation: >20 dBc @ Fout= 20 GHz 100 KHz SSB Phase Noise: -135 dBc/Hz Single Supply: +5V@ 48 mA RoHS Compliant 3x3 mm SMT Package

General Description

The HMC448LC3B is a x2 active broadband frequency multiplier utilizing GaAs PHEMT technology in a leadless RoHS compliant SMT package. When driven by a 0 dBm signal, the multiplier provides +11 dBm typical output power from 22 to 25 GHz. The Fo and 3Fo isolations are >20 dBc up to 22 GHz. This multi-rate frequency multiplier can be used in the generation of a half rate clock for 40 Gbps systems or as part of a multiplier chain to generate a full rate 40 Gbps clock. The HMC448LC3B is also ideal for use in LO multiplier chains for Pt to Pt & VSAT Radios yielding reduced parts count vs. traditional approaches. The low additive SSB Phase Noise of -135 dBc/Hz at 100 kHz offset helps maintain good system noise performance. The HMC448LC3B eliminates the need for wire bonding, allowing the use of surface mount manufacturing techniques.

Electrical Specifications, $T_{A} = +25^{\circ}$ C, Vdd = +5V, 0 dBm Drive Level

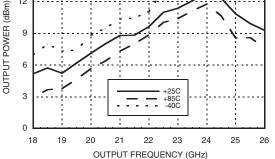
- A							
Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range, Input		10 - 11			11 - 12.5		GHz
Frequency Range, Output	20 - 22		22 - 25			GHz	
Output Power	5	9		7.5	11		dBm
Fo Isolation (with respect to output level)		24			15		dBc
3Fo Isolation (with respect to output level)		25			25		dBc
Input Return Loss		10			7		dB
Output Return Loss		6			10		dB
SSB Phase Noise (100 kHz Offset)		-135			-135		dBc/Hz
Supply Current (Idd)		48			48		mA



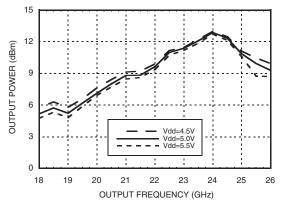


SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 20 - 25 GHz OUTPUT

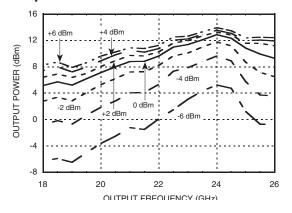
Output Power vs. Temperature @ 0 dBm Drive Level



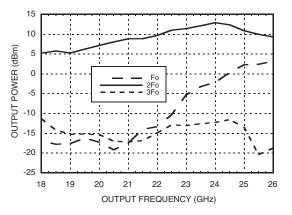
Output Power vs. Supply Voltage @ 0 dBm Drive Level

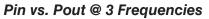


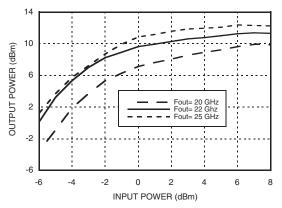
Output Power vs. Drive Level



Isolation @ 0 dBm Drive Level



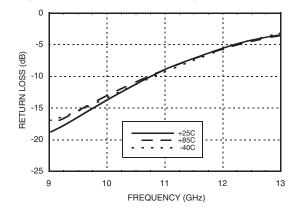








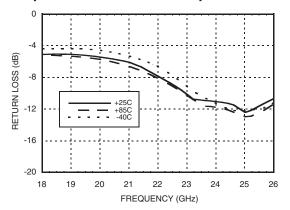
Input Return Loss vs. Temperature



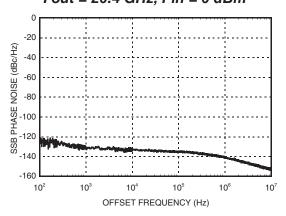
Output Return Loss vs. Temperature

MULTIPLIER, 20 - 25 GHz OUTPUT

SMT GaAs MMIC x2 ACTIVE FREQUENCY



SSB Phase Noise Performance, Fout = 20.4 GHz, Pin = 0 dBm







SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 20 - 25 GHz OUTPUT

Absolute Maximum Ratings

RF Input (Vcc= +5V)	+20 dBm	
Supply Voltage (Vdd)	+6.0 Vdc	
Channel Temperature	175 °C	
Continuous Pdiss (T= 85 °C) (derate 8.3 mW/°C above 85 °C)	744 mW	
Thermal Resistance (channel to ground paddle)	121 °C/W	
Storage Temperature	-65 to +150 °C	
Operating Temperature	-40 to +85 °C	

Typical Supply Current vs. Vdd

Vdd (Vdc)	ldd (mA)
4.5	47
5.0	48
5.5	49

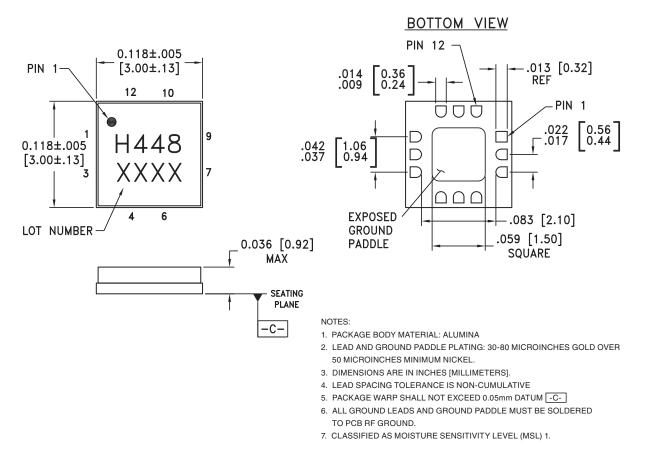
Note:

Multiplier will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing







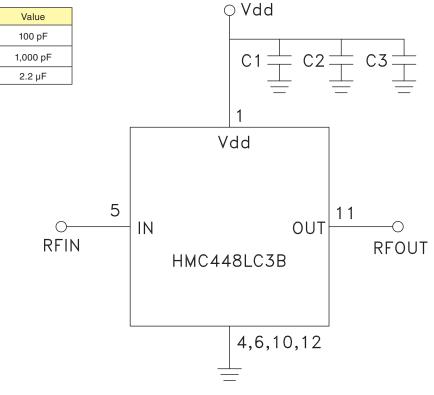
SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 20 - 25 GHz OUTPUT

Pin Description

Pin Number	Function	Description	Interface Schematic
1	Vdd	Supply voltage 5V ± 0.5V. External bypass capacitors of 100 pF, 1,000 pF and 2.2 μF are required.	Vdd
2, 3, 7-9	N/C	This pin may be connected to RF/DC ground. Performance will not be affected.	
4, 6, 10, 12	GND	Package bottom must also be connected to RF/DC ground.	GND =
5	RFIN	Pin is AC coupled and matched to 50 Ohm from 10.0 - 12.5 GHz.	
11	RFOUT	Pin is AC coupled and matched to 50 Ohm from 20 - 25 GHz.	

Application Circuit

Component	Value
C1	100 pF
C2	1,000 pF
C3	2.2 µF



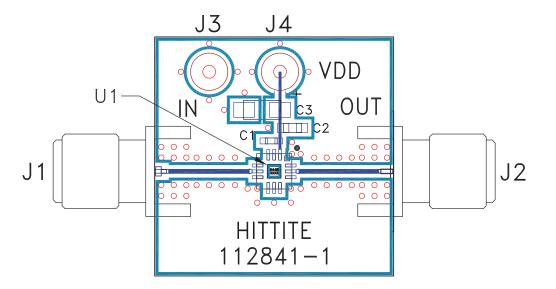




SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 20 - 25 GHz OUTPUT

ROHS

Evaluation PCB



List of Materials for Evaluation PCB 112697 [1]

Item	Description
J1	PCB Mount SRI SMA Connector
J2	PCB Mount SRI K Connector
J3 - J4	DC Pin
C1	100 pF Capacitor, 0402 Pkg.
C2	1,000 pF Capacitor, 0603 Pkg.
C3	2.2 µF Tantalum Capacitor
U1	HMC448LC3B x2 Active Multiplier
PCB [2]	112841 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. The evaluation circuit board shown is available from Hittite upon request. FREQ. MULTIPLIERS - ACTIVE - SMT